

## DESCRIPTION

The AM40T120B is available in TO-247 Package

VCES	IC	VCE	PD
1200V	40A	2.0V	357W

# FEATURES

- Fast Switching
- Low V<sub>CE(sat): 2.0V</sub>
- Positive Temperature Coefficient
- Very Soft, Fast Recovery Anti-Parallel Diode
- Irrm: 14.9A

**PIN DESCRIPTION** 

## APPLICATION

- UPS
- Welding Converters
- Converters With High Switching Frequency

## ORDERING INFORMATION

Package Type	Part Number			
TO-247	TL3F	AM40T120ATL3FU		
SPQ:30pcs/Tube		AM40T120ATL3FVU		
Noto	V: Halogen free Package			
Note	U: Tube			
AiT provides all RoHS products				



Pin#	Symbol	Function
1	G	Gate
2	С	Collector
3	E	Emitter



# ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Value	Units		
Collector-Emitter Voltage	VCES	1200	V		
Collector Current @ Tc = 25 °C	1	80	А		
Collector Current @ Tc = 100 °C	IC	40	А		
Pulsed Collector Current <sup>(1)</sup> @ Tc = 25 °C	Ісм	160	А		
Diode Continuous Forward Current @ Tc = 25 °C		40	А		
Diode Continuous Forward Current @ Tc = 100 °C	IF	20	А		
Diode Maximum Forward Current @ Tc = 25 $^{\circ}$ C	Ifm	160	А		
Gate-Emitter Voltage	V <sub>GES</sub>	±20	V		
Power Dissipation @ Tc = 25 °C	PD	357	W		
Storage Temperature Range	T <sub>stg</sub>	-55 to 150	°C		
Junction Temperature	TJ	150	°C		
Maximum Temperature for Soldering	T∟	260	°C		
THERMAL CHARACTERISTICS					
Junction-to-Case (IGBT)	Rejc	0.34	°C/W		
Junction-to-Case (Diode)	R <sub>ejc</sub>	0.8	°C/W		
Junction-to-Ambient	Reja	40	°C/W		

Stresses above may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated in the Electrical Characteristics are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

(1) Pulse width limited by maximum junction temperature



## **ELECTRICAL CHARACTERISTICS**

 $T_A=25^{\circ}C$ , unless otherwise specified.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units	
OFF CHARACTERISTICS							
Collector-Emitter Breakdown Voltage	VCES	V <sub>GE</sub> =0V, I <sub>C</sub> =250µA	1200	-	-	V	
Collector-Emitter Leakage Current	ICES	$V_{CE}$ = 1200V, $V_{GE}$ = 0V	-	-	250	μA	
Gate-Emitter Leakage Current	IGES(F)	V <sub>GE</sub> = +20V	-	-	600	nA	
Gate-Emitter Reverse Leakage	I <sub>GES(R)</sub>	V <sub>GE</sub> = -20V	-	-	-600	nA	
ON CHARACTERISTICS							
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> = 15V, I <sub>C</sub> =40A	-	2.0	2.4	V	
Gate Threshold Voltage	V <sub>GE(TH)</sub>	V <sub>CE</sub> = V <sub>GE</sub> , I <sub>C</sub> = 1mA	5.5	5.8	6.5	V	
Pulse width tp≤300μs, δ≤2%							
DYNAMIC CHARACTERISTICS							
Input Capacitance	Ciss	V <sub>GE</sub> = 0V	-	3633	-		
Output Capacitance	Coss	V <sub>CE</sub> = 25V	-	150	-	pF	
Reverse Transfer Capacitance	Crss	f = 1.0MHz	-	90	-		
		I <sub>C</sub> = 40A					
Total Gate Charge	Qg	V <sub>CE</sub> = 960V	-	270	-	nC	
		V <sub>GE</sub> = 15V					
SWITCHING CHARACTERISTICS							
Turn-on Delay Time	t <sub>d(ON)</sub>	I <sub>C</sub> =40A	-	48	-		
Rise Time	tr	V <sub>CE</sub> = 600V	-	90	-		
Turn-Off Delay Time	$t_{d(OFF)}$	V <sub>GE</sub> = 15V	-	275	-	ns	
Fall Time	t <sub>f</sub>	R <sub>G</sub> =10Ω	-	55	-		
Turn-On Switching Loss	Eon	Inductive Load	-	4.694	-		
Turn-Off Switching Loss	E <sub>off</sub>		-	1.627	-	mJ	
Total Switching Loss	Ets		-	6.321	-		
DIODE CHARACTERISTICS							
Diode Forward Voltage	VF	I <sub>F</sub> =40A	-	2	2.5	V	
Reverse Recovery Time	Trr	1 - 404	-	73	-	nS	
Reverse Recovery Charge	Qrr	IF=4UA,	_	654	_	nC	
Reverse Recovery Current	Irrm	ai/dt=200A/US	-	14.9	-	А	



## TYPICAL PERFORMANCE CHARACTERISTICS





Fig.3 Collector Current vs Case Temperature



Fig.5 Typical Output Characteristics(T<sub>C</sub>=25°C)



Fig.2 Power Dissipation vs Case Temperature



Fig.4 Typical Transfer Characteristics



Fig.6 Typical Output Characteristics(T<sub>C</sub>=150°C)





# Fig.7 Typical Collector-Emitter Saturation Voltage vs Junction Temperature



Fig.9 Typical Gate Charge



Fig.11 IGBT Transient Thermal Impedance



### Fig.8 Typical Transfer Characteristics



Fig.10 Typical Capacitance

vs Collector- Emitter Voltage



Fig.12 Diode Transient Thermal Impedance vs Pulse Width





### Fig.13 Typical Diode Forward Current



Fig.15 Inductive Switching Waveforms



Fig.17. Inductive Switching Waveforms



#### Fig.14 Inductive Switching Test Circuit



Fig.16. Inductive Switching Waveforms





## PACKAGE INFORMATION

Dimension in TO-247 (Unit: mm)



Symbol	Min.	Max.	Symbol	Min.	Max.	
A	4.900	5.160	D2	1.050	1.350	
A1	2.270	2.530	E	15.700	16.030	
A2	1.850	2.110	E1	13.100	14.150	
В	1.070	1.330	E2	3.680	5.100	
B1	1.900	2.410	E3	1.680	2.600	
B2	1.750	2.150	е	5.440		
B3	2.870	3.380	L	19.800	20.310	
B4	2.870	3.130	L1	4.170	4.470	
С	0.550	0.680	ΦΡ	3.500	3.700	
D	20.820	21.100	Q	5.490	6.000	
D1	16.250	17.650	S	6.040	6.300	



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